

### **SPECIFICATION SHEET**

SDECIFICATION SHEET NO	Q0618-CP2M000000S047
SPECIFICATION SHEET NO.	Q0018-CF2IVI0000003047
DATE	June 18, 2023
DAIL .	
REVISION	A0
DESCRIPITION	MHz SMD Ceramic Resonator, 6030 Type, L6.0*W3.0*H1.8mm,
	Built-in Capacitance, 3 pads, CRTP Series
	2.000MHz, Frequency Accuracy ±0.5%,
	Operating Temp. Range -25°C ~+85°C,
	Reflow Profile Condition 260 °C Max.
	RoHS/RoHS III compliant, Tape/Reel, 4000pcs/Reel
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	TGS CRTP 2.0MG-47 TLF
PART CODE	CP2M000000S047

#### **VENDOR APPROVE**

Issued/Checked/Approved

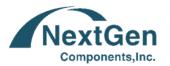






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### **SMD CERAMIC RESONATOR CRTP SERIES**

#### MAIN FEATURE

- SMD Ceramic Resonator, L6.0\*W3.0\*H1.8mm, 3 pads
- Low cost & Built-in Capacitance
- Reflow Profile Condition 260 °C Max.
- Wide Frequency Range
- Cross more competitors part
- RoHS III compliant

#### **APPLICATION**

- Bluetooth, wireless communication set
- Communication Electronics

#### **PART CODE GUIDE**



СР	2M000000	S	047
1	2	3	4

- 1) CP: Part Code for SMD Ceramic Resonator, Built-in Capacitance, 3 pads, L6.0\*W3.0\*H1.8mm, CRTP SERIES
- 2) 2M000000: Frequency range code for 2.00000MHz
- 3) S: SMD type, Package Tape/Reel, 1000pcs/Reel
- 4) 047: Specification code for original part No.: TGS CRTP 2.0MG-47 TLF

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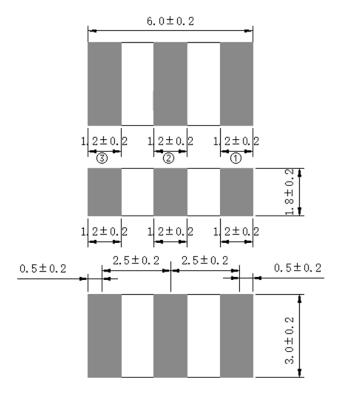
# **SMD CERAMIC RESONATOR CRTP SERIES**

#### **DIMENSION (Unit: mm)**

#### Image for reference

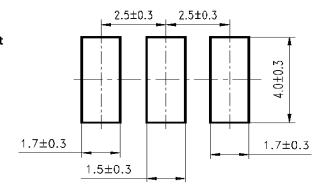
**CRTP** 



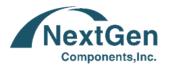


- 1 Input
- (2)Ground
- 3 Output

#### **Recommend Pad Layout**



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### **SMD CERAMIC RESONATOR CRTP SERIES**

#### **ELECTRICAL PARAMETERS**

Parame	ter	Part No.	Units		Value		Condition
		Symbol		Min.	Typical	Max.	_
Original	Manufacturer	TGS		TGS	Crystals		
Holder 1	Гуре	CRTP	SMD Ceram	ic Resonator	, L6.0*W3.0*H1.8m	m, 3 pads	
Frequen	ncy Range	2.0	MHz		2.00000		
Withsta	nding Voltage	MG	V	100			@DC, 1 min
Insulatio	on Resistance		МΩ	500			@AV, 1 min.
Operation	on Temperance		°C	-25		+85	
Storage	Temperance		°C	-55		+85	
Rating V	/oltage		V		6		DC
					15		р-р
Frequen	ncy Accuracy		%	±0.5			
Resonar	nt Impedance		Ω			100	
Temper of Oscill Frequen			%			±0.3	Oscillation Frequency drift, -25°C ~ +85°C)
	on Frequency ate (10 years)		%			±0.3	From initial value
IC applic	cation			1/6TC4069UBP×2			
Design I	Mode						
Built-in	Capacitance	-47	pF		47pF (±20%)		
Package		Т	Tape/Reel				
	RoHS Status	RoHS Status LF RoHS III compliant			_		
Other	Add Value				N/A		1
	Internal Control Code			2 letter or o	ligits; Blank: N/A		

Note: Original Part Number: TGS CRTP 2.0MG-47 TLF

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# **SMD CERAMIC RESONATOR CRTP SERIES**

#### **RELIABILITY**

Test Items	Test Method And Conditions	Performance Requirements
Humidity	Keep the resonator at 60°C±2°C and 90%-95% RH for 96h.  Then Release the resonator into the room Condition for 1h prior to the Measurement.	It shall fulfill the specifications in Table 1.
High Temperature Exposure	Subject the resonator to 85°C±2°C for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
Low Temperature Exposure	Subject the resonator to -40°C $\pm$ 2°C for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
Temperature Cycling	Subject the resonator to -25°C±3°C for 30±3 min. followed by a high temperature of 85°C ±3°Cfor 30±3 min.  Cycling shall be repeated 5 times with a transfer time of 15s.  At the room temperature for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
Vibration	Subject the resonator to vibration for 2h each in x, y and z axis With the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10 Hz—55Hz.	It shall fulfill the specifications in Table 1.
Mechanical Shock	Drop the resonator randomly onto a wooden floor from the height of 100cm 3 times.	It shall fulfill the specifications in Table 1.
Soldering Test	Passed through the re-flow oven under the following condition and left at room temperature for 1h before measurement	It shall fulfill the specifications in Table 1.
Solder Ability	Dipped in 245°C±5°C solder bath for 3s±0.5 s with rosin flux (25wt% ethanol solution.)	The terminals shall be at least 95% covered by solder.
Board Bending	Mount a glass-epoxy board (Width=40mm,thickness=1.6mm),then bend it to 1mm displacement and keep it for 5s. (See the following figure 1)	Mechanical damage such as breaks shall not occur.

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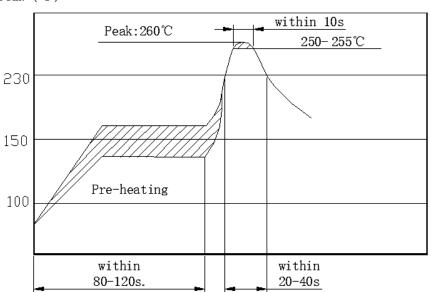
### **SMD CERAMIC RESONATOR CRTP SERIES**

#### Table 1

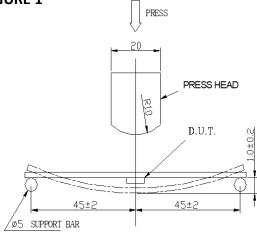
Item	Specification after test	
Oscillation Frequency Change △Fosc/Fosc (%) max	±0.3	
Resonant Impedance (Ω) max 100		
The limits in the above table are referenced to the initial measurements.		

### **SUGGESTED REFLOW PROFILE (For Reference Only)**

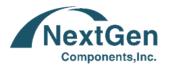






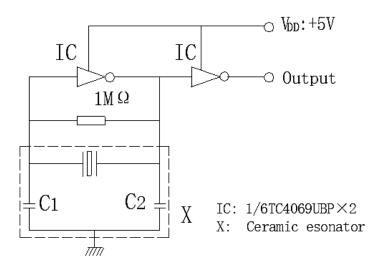


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# **SMD CERAMIC RESONATOR CRTP SERIES**

### **TEST CIRCUIT (For Reference Only)**



#### Note:

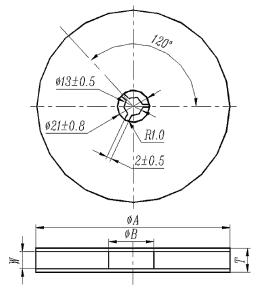
Parts shall be tested under the condition ( Temp.:  $20\pm15^{\circ}$ C, Humidity  $65\pm20\%$  R.H.) unless the standard condition(Temp.:  $25\pm3$  °C, Humidity : $65\pm10\%$  R.H.) is regulated to measure.

### **SMD CERAMIC RESONATOR CRTP SERIES**

#### TAPE/REEL (Unit: mm)

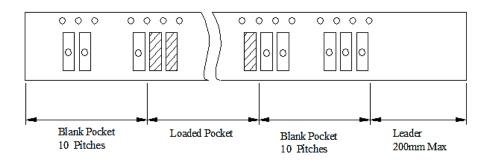
All Devices are packed in accordance with EIA standard RS-481-2 and specifications, 4000pcs/Reel, Carrier tape size-16,

Reel

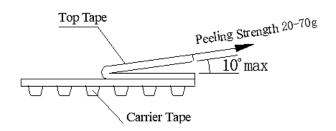


Symbol	Dimension
фА	330±3.0
фВ	80.0 Min.
W	16.4 Min.
Т	22.4 Max.

Packing Method Sketch Map



Test Condition
Of Peeling Strength



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### **SMD CERAMIC RESONATOR CRTP SERIES**

#### **NOTES**

- Don't apply excess mechanical stress to the component and terminals at soldering. Do not use this product with bend.
- Do not clean or wash the component for it is not hermetically sealed.
- Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.
- · Don't be close to fire.
- This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit
- Expire date (Shelf life) of the products is 12 months after delivery under the conditions of a sealed and an unopened package. Please use the products within 12 months after delivery. If you store the products for a long time (more than 12 months), use carefully because the products may be degraded in the solder-ability or rusty. Please confirm solder-ability and characteristics for the products regularly.
- Exposure components under soldering condition that is exceeding our recommendation will increase the failure dangerous.
- Please contact us before using the product as automobile electronic component.
- Please return one of these specifications after your signature of acceptance.
- When something gets doubtful with this specifications, we shall jointly work to get an agreement.
- For questions on technology, prices and delivery, please contact our sales offices or e-mail: sales@NextGenComponent.com .

#### **DISCLAIMER**

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